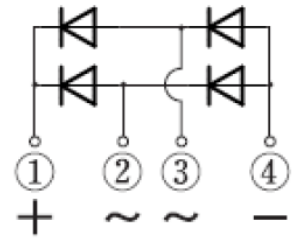


## LTspice Model Bridge Diode SHINDENGEN D20XB60



### Model Information

**Model** A macro model based on general SPICE diode model  
**Call Name** MDC\_D20XB60\_LT  
**Pin Assign** 1:Out+ 2:In1 3:In2 4:Out-  
**File List** Model Library MDC\_D20XB60\_LT01.lib  
 Model Report MDC\_D20XB60\_LT.pdf (this file)

**Verified Simulator Version** LTspice version XVII  
**Note**

### References

The information which was used for modeling is as follow:

[Data Sheet]

- Date/Version Rev.01(2020.01)
- Product name D20XB60
- Company name Shindengen Electric Manufacturing Co., Ltd.
- Characteristics IfVf[Temp],IrVr[Temp],BridgeWaveform,SurgeWaveform

### Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Range			Unit
	Min.		Max.	
Reverse Voltage	0	to	600	V
Temperature	-40	to	150	deg C

## Diode

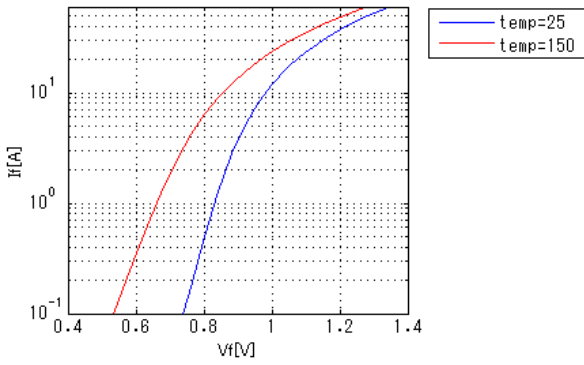
○ : Implemented  
× : Not Implemented  
— : Not applicable

**Model Functions Table**
**RANK=1**

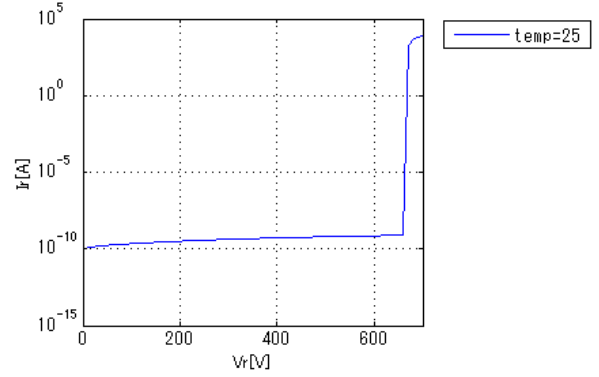
Functions	RANK	Implemented
IF-VF(Temp)	1	○
IR-VR(Temp)	1	○
Capacitance	1	—
Reverse recovery characteristics	1	—
Rectification characteristics(Bridge)	1	○
Surge voltage-Transient	2	—

Simulation results are following.  
 Explanatory notes — : simulated

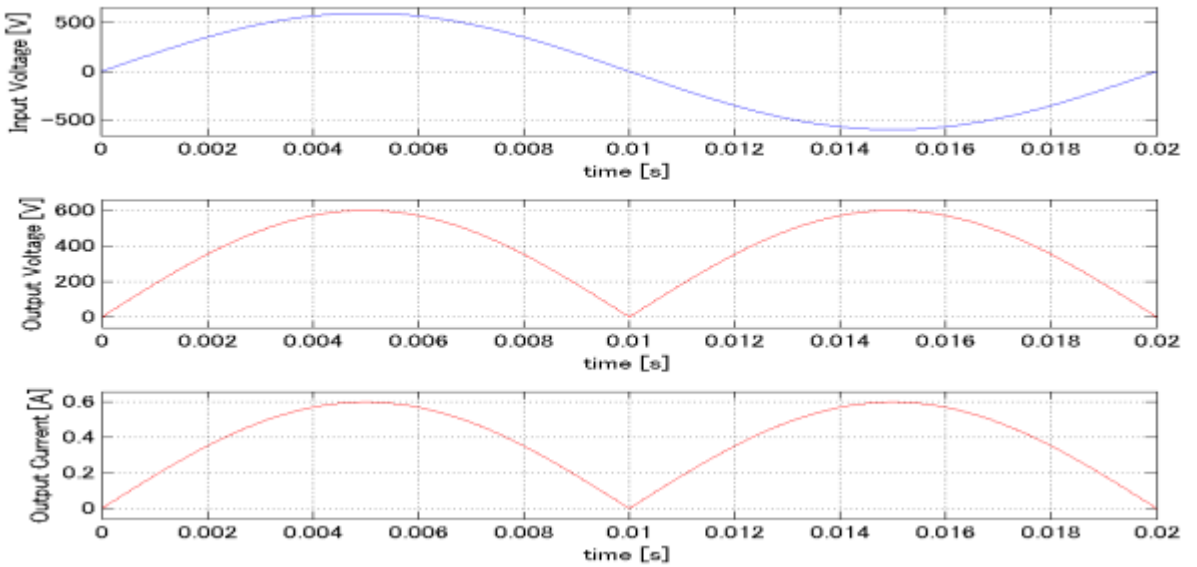
**IfVf[Temp]**



**IrVr[Temp]**



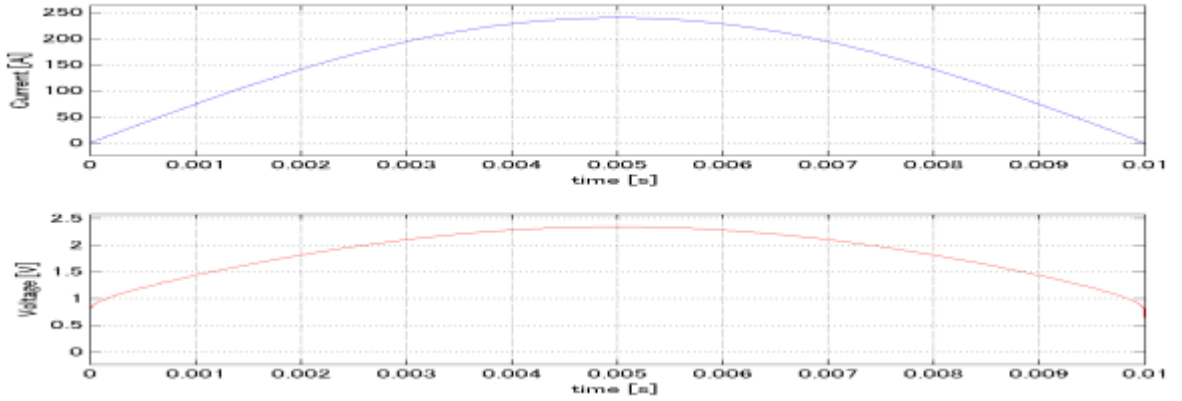
**Bridge Waveform**



Simulation results are following.  
Explanatory notes — : simulated

### Surge Forward Waveform

Half Sine Wave 50Hz



## DISCLAIMER

1. This SPICE (Simulation Program with Integrated Circuit Emphasis) model and its content (the "Contents") are copyright of MoDeCH Inc. All rights reserved. Any redistribution or reproduction of any or all part of the Contents in any form is prohibited without express written permission made by MoDeCH Inc.
2. MoDeCH Inc. as licensor (the "Licensor") hereby grants to you, as licensee (the "Licensee"), a non-exclusive, non-transferable license to use the Contents as long as you abide by the terms and conditions of this DISCLAIMER.
3. The Licensee is not authorized to sell, loan, rent and redistribute or license the Contents in whole or in part, or in modified form, to anyone.
4. The Licensor shall in no way be liable to the Licensee or any third party for any loss or damage (including, but not limited to, lost profits, or other incidental, consequential, or punitive damages), however caused (including through negligence) which may be directly or indirectly suffered from, arising out of, or in connection with, any use of the Contents .
5. Notwithstanding anything contained in this DISCLAIMER, in no event shall Licensor be liable for any claims, damages or loss which may arise from the modification, combination, operation or use of the Contents with the Licensee's computer programs.
6. The Licensor does not warrant that the Contents will function in any environment.
7. The Contents may be changed or updated without notice. MoDeCH Inc. may also make improvements and/or changes in the products, pricing and/or the programs related to the Contents at any time without notice.



MoDeCH Inc.

Head Office

Location: Taiju-Seimei-Hachioji Bldg., 5-15 Yokoyama-cho, Hachioji-Shi, Tokyo 192-0081, Japan

Tel:+81-42-656-3360

E-Mail:[model-on-support@modech.co.jp](mailto:model-on-support@modech.co.jp)

URL:<http://www.modech.com/en/>